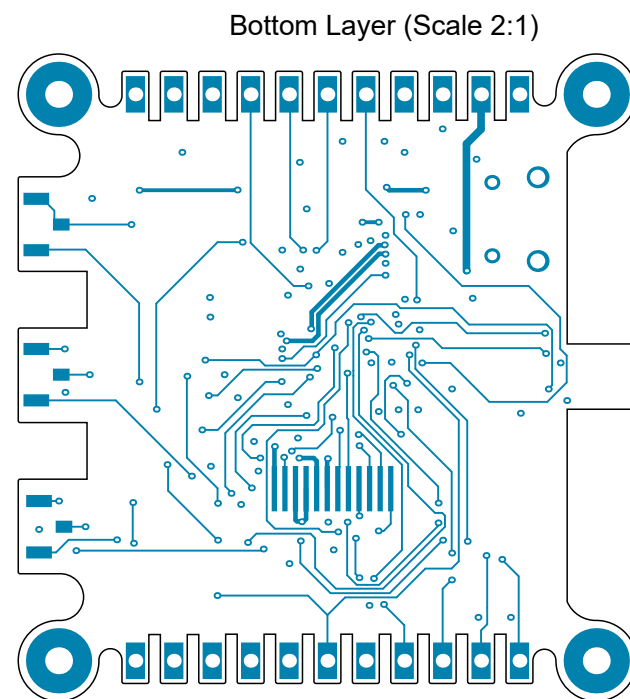



1. Overall PCB Dimensions: 40.9mm x 42.8mm
2. Route to shape on board outline layer .GM8.
3. PCB material shall be FR-4 with min Tg of 140C
4. Copper density shall be 1oz/sq in on all layers
5. Gold ENIG finish on pads
6. LPI solder mask color : RED
7. Legend color - WHITE
8. Minimum drill size : 10mil
9. Minimum trace spacing : 5mil
10. Minimum trace width : 5mil
11. See file with .extrep extension for gerber layer assignments
12. NC Drill file will have a .txt extension
13. 4-Layer stackup with nominal 62.5mil finished thickness +/- 10%
14. Alternate stackup/materials may be used with prior written permission
15. PCB shall be fully electrically tested



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